



Metal-free C–N bond-forming reaction: straightforward synthesis of anilines, through cleavage of aryl C–O bond and amide C–N bond

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ABSTRACT

An efficient metal-free C–N bond forming reaction through cleavage of aryl C–O bond and amide C–N bond has been developed. This process represents a practical method for the facile construction of anilines with a broad substrate scope and wide functional group tolerance in moderate to excellent yields.

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Anilines are important intermediates for the synthesis of agrochemicals, pharmaceuticals, dyes, and pigments. Traditionally, the manufacturing processes for anilines are based on aromatic nitration and the continuous catalytic hydrogenation of nitroaromatic compounds. Both of them are limited to the preparation of those molecules containing sensitive functional groups. In addition, these processes generate a large amount of waste liquid in the use of sulfuric acid and nitric acid and cause environmental pollution.^{1,2} Recent progresses of aniline synthesis via transition-metal-catalyzed cross-coupling reaction of aryl halides with ammonia or ammonia surrogates have been reported.³ The palladium-catalyzed synthesis of anilines has been developed through couplings of aryl halides (X= I, Br, Cl) or phenol derivatives with ammonia.⁴ Similarly, the copper-catalyzed coupling reaction of ammonia with aryl iodides or aryl bromides is available, while the coupling with less reactive but more economically attractive aryl chlorides does not occur.⁵ Also, the copper-catalyzed reaction of aromatic boronic acids with ammonia enables direct access to anilines.⁶ Despite remarkable advances, there are some notable limitations. Particularly, the presence of heavy transition-metal impurities in the final products remains a major problem. A wide variety of functional groups, including iodo and bromo moieties are typically sensitive in palladium- and copper-catalyzed coupling reactions. For these reasons, the development of metal-free methods will probably provide new ways for constructing anilines.⁷

Phenols and their derivatives are common reagents.⁸ The aryl C–O bond is generally ‘inert’ so that the cleavage of aryl C–O bond is very difficult.⁹ Only very few examples have been reported for the construction of anilines starting from phenol-derived compounds under metal-free conditions.¹⁰ For example, the alkylation-Smiles rearrangement-hydrolysis sequence has been used for the preparation of anilines, but this method requires harsh reaction conditions and has limited substrate scope.^{10b} Herein, we report the example of metal-free cleavage of aryl C–O bond and amide C–N in aryloxyamides, which leads to the formation of new C–N bond. Use of this type reaction provides an efficient and straightforward access to anilines. This general method has highly appreciated qualities of a chemical transformation, including simple operation, high selectivity, and affordable starting materials.

Initially, we selected aryloxyamides **1–7** as our model system for the investigation of C–N bond-forming reaction. We treated aryloxyamides with sodium hydroxide as base (2.0 equiv) in *N,N*-dimethylformamide solvent at 140 °C (Table 1). No expected C–N bond-forming reactions were observed with **1**, **2**, and **3** (Table 1, entries 1–3, yields <5%). To our delight, the desired C–N bond-forming reaction was observed with **4** (Table 1, entry 4), albeit in low yield. Then, we tested the variation of R¹ groups (R²=H). Compared with aryloxyamides **5** and **6**, the use of aryloxyamide **7** performed much better in the C–N bond-forming reactions, producing the highest yield up to 55% (Table 1, entries 5–7). As a result, we found that carbon chain length (*n*) and substituents (R¹ and R²) had a large effect on the C–N bond formation and aryloxyamide **7** (*n* = 0, R¹ = CH₃, R² = H) was identified as the best substrate in the synthesis of anilines.

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Table 1
Optimization studies for aryloxyamides **1–7** as substrates for C–N bond-forming reactions^a

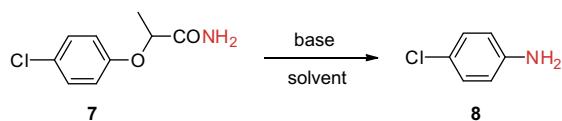


Entry	Aryloxyamides	n	R ¹	R ²	Yield ^b (%)
1	1	0	CH ₃	CH ₃	<5
2	2	0	COCH ₃	H	nr
3	3	1	H	H	nr
4	4	0	H	H	32
5	5	0	Ph	H	50
6	6	0	CONH ₂	H	47
7	7	0	CH ₃	H	55

^a Reaction conditions: **1** (1.0 mmol), NaOH (2.0 mmol), DMF (4.0 mL), 140 °C, 3 h.

^b Isolated yield after column chromatography.

Table 2
Optimization studies for reaction conditions^a



Entry	Base (equiv)	Solvent	Temp/Time	Yield ^b (%)
1	K ₂ CO ₃ (2.0)	CH ₃ CN	Reflux/16 h	n.r.
2	K ₂ CO ₃ (2.0)	DMF	Reflux/16 h	n.r.
3	Cs ₂ CO ₃ (2.0)	DMF	Reflux/16 h	n.r.
4	NaH (2.0)	DMF	Reflux/16 h	13
5	NaOH (2.0)	DMF	120 °C/3 h	9
6	NaOH (2.0)	DMF	140 °C/3 h	55
7	KOH (2.0)	DMF	140 °C/3 h	60
8	KOH (2.0)	DMAC	140 °C/3 h	55
9	KOH (2.0)	DMSO	140 °C/3 h	65
10	KOH (2.0)	DMSO	160 °C/3 h	63
11	KOH (2.0)	DMSO/DMPU (3:1)	140 °C/3 h	65
12	KOH (2.0)	DMPU	140 °C/3 h	64
13	KOH (1.0)	DMSO	140 °C/3 h	48

^a Reaction conditions: **7** (1.0 mmol), base (1.0–2.0 mmol), solvent (4.0 mL).

^b Isolated yield after column chromatography.

Next, aryloxyamide **7** was chosen as the model substrate to optimize the reaction conditions. Bases, solvents, and co-solvent were investigated at varied temperature (**Table 2**). We observed that the C–N bond-forming reaction proceeded to afford the product **8** in the presence of a variety of bases, and KOH was the best choice in the formation (**Table 2**, entry 7). Different solvents were also investigated, and dimethyl sulfoxide (DMSO) was the optimal solvent (**Table 2**, entry 9). 1,3-Dimethyl-3,4,5,6-tetrahydro-2(1*H*)-pyrimidinone (DMPU) is often used as a co-solvent,¹¹ and the same activity was shown with DMSO/DMPU (3:1 ratio; **Table 2**, entry 11). We were pleased to find that the reaction also proceeded to give **8** even in the presence of 1.0 equiv of KOH, albeit in a decrease in isolated yield (**Table 2**, entry 13). After the screening, the optimum conditions for C–N bond-forming reaction were as follows: KOH as base, DMSO as solvent, DMPU as co-solvent, and the reaction was carried out at 140 °C.

We then explored the scope of this novel method. As shown in **Table 3**, all the substrates **9** derived quite easily from the corresponding phenols were examined under the standard reaction conditions. We found that the substrates containing electron-deficient, electron-neutral, and electron-rich groups at the *para*-, *meta*-, or

ortho-positions provided moderate to excellent yields. Some substrates containing electron-neutral and electron-rich groups in DMSO as reaction solvent were found with very low yields (**Table 3**, **10d–f**). Delightedly, we found that the use of DMPU as co-solvent could dramatically increase the reactivity for the formation (**10d–f**). The method showed a wide substrate scope with good functional group tolerance. The aryloxyamides containing halogen substituted groups, such as F, Cl, Br, and I (**10l–s**), showed good reactivity, which offered an opportunity for further derivatizations through transition-metal-catalyzed techniques. Moreover, the substrates containing base-sensitive groups including the nitro, ester, aldehyde, and ketone groups were obtained successfully in the presence of only 1.0 equiv of KOH in moderate to high yields (**10t–w**). The 2-(2,3,6-trimethylphenoxy) propanamide, 2-(2,6-di-methyl phenoxy) propanamide, and 2-(4-bromo-2,6-dimethyl phenoxy) propanamide, which are more sterically hindered with two methyl groups at the C2 and C6 positions, also led to moderate yields (**10x–z**). Polycyclic-based substrates could be transformed to the corresponding anilines (**10aa–bb**). It is noteworthy that heteroaryl substrates could also be successfully converted into the corresponding anilines (**10cc–dd**).

Table 3Scope of metal-free synthesis of anilines^a

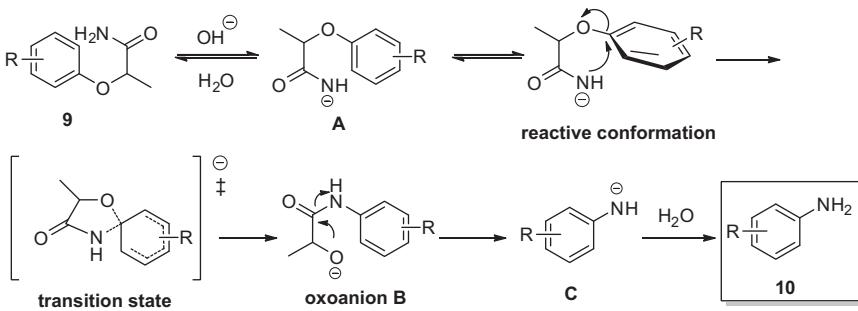
	KOH (1-2 eq.)	ArNH ₂
	DMSO or DMSO/DMPU(3:1)	
	140 °C, 3-16 h	
10a 6h 48% ^b		10d 16h 5% ^a , 41% ^b
10b 3h 76%		
10c 4h 90%		
10e 16h 0%, 38% ^b		
10f 6h 5% ^a , 56% ^b		
10g 6h 62%		
10h 8h 87%		
10i 3h 53%		
10j 16h 39%		
10k 3h 95%		
10l 16h 35% ^b		
10m 3h 86%		
10n 3h 85%		
10o 6h 71%		
10p 4h 65%		
10q 4h 60%		
10r 4h 52%		
10s 3h 77%		
10t 3h 83% ^c		
10u 8h 48% ^c		
10v 8h 56% ^c		
10w 6h 81% ^c		
10x 16h 45% ^b		
10y 16h 50% ^b		
10z 8h 64%		
10aa 6h 56%		
10bb 6h 81%		
10cc 8h 48%		
10dd 8h 79% ^b		

^aReaction conditions: **9** (1.0 mmol), KOH (2.0 mmol), DMSO (4 mL), 140 °C.^bReaction conditions: **9** (1.0 mmol), KOH (2.0 mmol), DMSO (3 mL) and DMPU (1 mL), 140 °C.^cReaction conditions: **9** (1.0 mmol), KOH (1.0 mmol), DMSO (4 mL), 140 °C.

Our proposed mechanism for the reaction is shown in **Scheme 1**. The first step of the reaction is the formation of the aryloxyamide anion **A**, a nucleophile by deprotonation of **9** in the presence of hydroxide ion.¹² The nucleophile attacks the aromatic nucleus in an *ipso* fashion to form a five-membered transition state.¹³ Breaking of the C–N bond in the transition state regenerates aryloxyamide anion **A** in an unproductive process. Breaking of the C–O bond in the transition state leads to the formation of oxoanion **B**

in a productive process. Oxoanion **B** attacks carbonyl carbon via an intramolecular nucleophilic addition to break the C–N bond, releasing the anilinium ion **C**.¹⁴ This anilinium ion **C** captures proton from water to give the final product aniline **10**.

In conclusion, an efficient and metal-free method for constructing anilines from aryloxyamides through cleavage of aryl C–O bond and amide C–N bond has been developed. This transformation is an extremely simple way and offers anilines in moderate to excellent

**Scheme 1.** Plausible reaction mechanism.

yields via more environmentally benign processes. The reaction displays a broad scope of substrates and tolerates a number of functional groups, including halogen and base-sensitive groups. We believe that the method should have potential to become a widely used transformation in many applications and further researches are going on in our laboratory.

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Supplementary data

Supplementary data associated with this article can be found, in the online version, at <http://dx.doi.org/10.1016/j.tetlet.2013.04.028>.

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